

Docket No. 280433US0PCT



LFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Kyoyu YASUDA, et al.

SERIAL NO: 10/580,456

GAU: 2811

FILED: May 24, 2006

EXAMINER:

FOR: HOT MELT ADHESIVE COMPOSITION

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☒ The applicant(s) wish to make of record the reference(s) cited in the attached Singapore Search Report and Written Opinion and listed on the attached form PTO-1449. Copies of the listed reference(s) are attached, where required, as are either statements of relevancy or any readily available Unedited Computer-Generated English translations of pertinent portions of any non-English language reference(s).
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☐ Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030.

Respectfully submitted,

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Form PTO 1449
(Modified)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY DOCKET NO.
280433US0PCTSERIAL NO.
10/580,456

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Kyouyu YASUDA, et al.

FILING DATE

May 24, 2006

GROUP

2811

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	5,798,790	08/25/1998	Andrew KNOX, et al.			
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AO	0 888 786 A2	01/07/1999	EUROPE (corr. to JP 11-92742 previously filed on May 24, 2006)		
	AP	10-71660	03/17/1998	JAPAN (corr. US 5,798,790, English Abstract previously filed on May 24, 2006)		X
	AQ	AU-B-33101/95	05/09/1996	AUSTRALIA (corr. to JP 8-239638 previously filed on May 24, 2006)		
	AR	0 537 115 A1	04/14/1993	EUROPE (corr. to JP 5-214307 previously filed on May 24, 2006)		
	AS	1 268 701 B1	08/11/2004	EUROPE		
	AT	11-181386	07/06/1999	JAPAN (with English Abstract, and Unedited Computer-Generated English translation)	X	
	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	Susan BUDAVARI, "The Merck Index", Merck & Co., Inc., published 1989, 1 front page, pages 574, 341-342				
	AX					
	AY					
	AZ				<input type="checkbox"/> Additional References sheet(s) attached	

Examiner

Date Considered

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.